

Opzioni per un timing layer dedicato con scintillatori e SiPM a FCC

Marco Lucchini

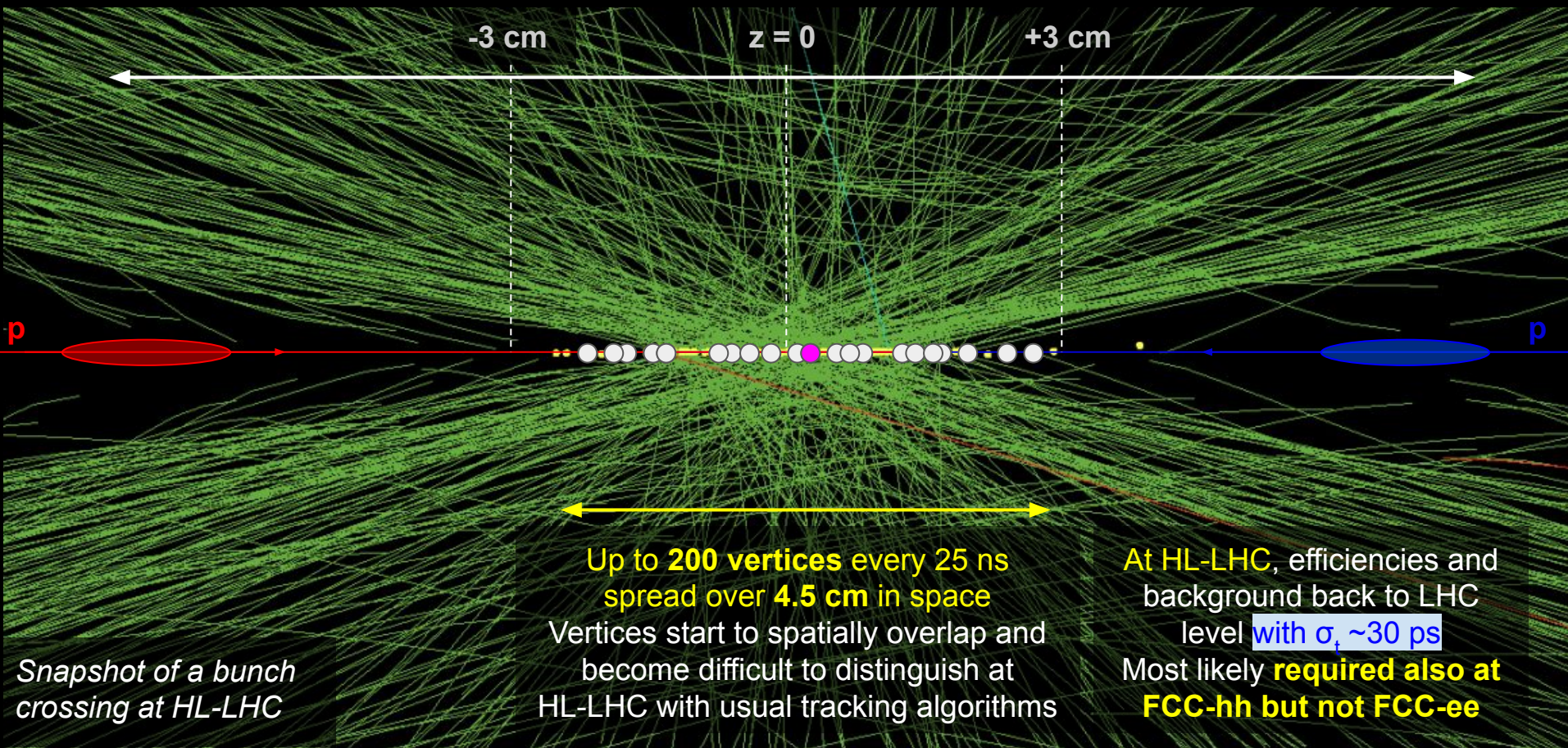
22-23/04/2024

RD_FCC WP Silicon Mini-Workshop

Why and what timing at FCC colliders?

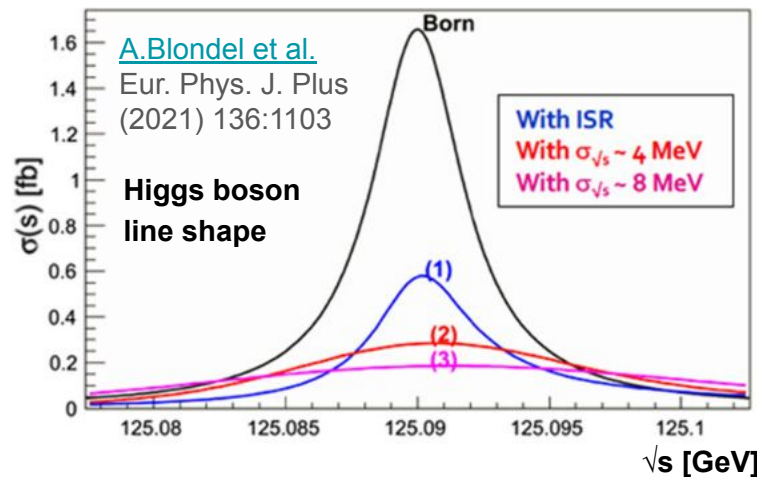
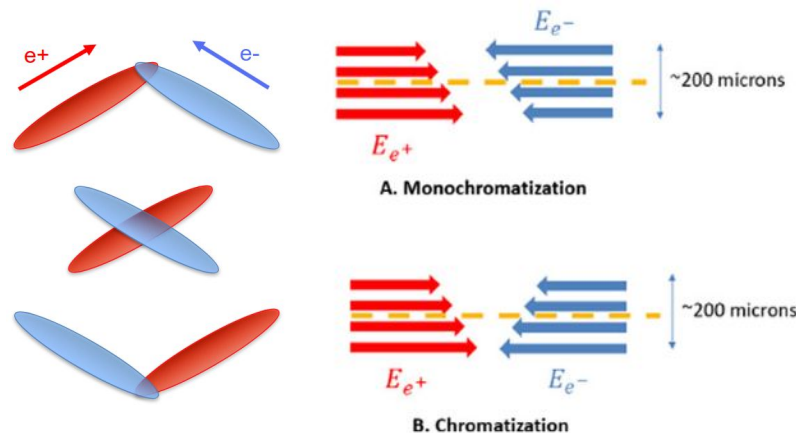
- Three use-case categories for precision timing in collider detectors:
(see [T.Tabarelli's talk at Snowmass 2022](#) for a sharp overview of the topic)
 - Vertex timing (from track timing)
 - Time-of-flight
 - Calorimetry (timing of neutrals and temporal structure of showers)
- Use-cases and detector requirements for e^+e^- and hh are different, focus on:
 - MIP timing *before* the calorimeter
 - *e^+e^- collider environment* (closest time horizon)
 - *Scintillator based* timing detectors capitalizing the past ten year efforts to design and integrate the Mip Timing Detector in the CMS experiment [[CMS-MTD-TDR](#)]

Vertex timing for pileup mitigation at hadron colliders



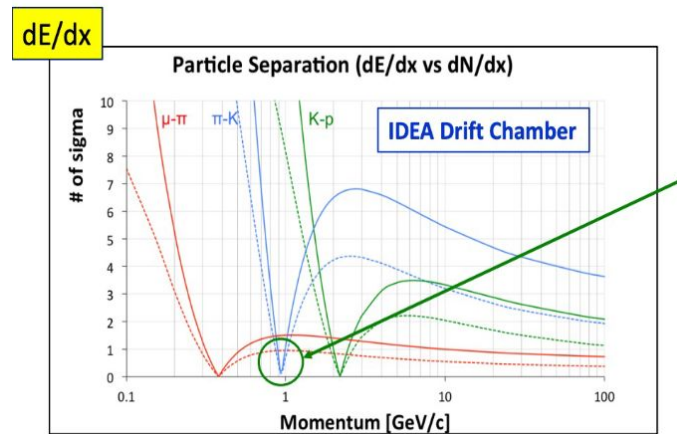
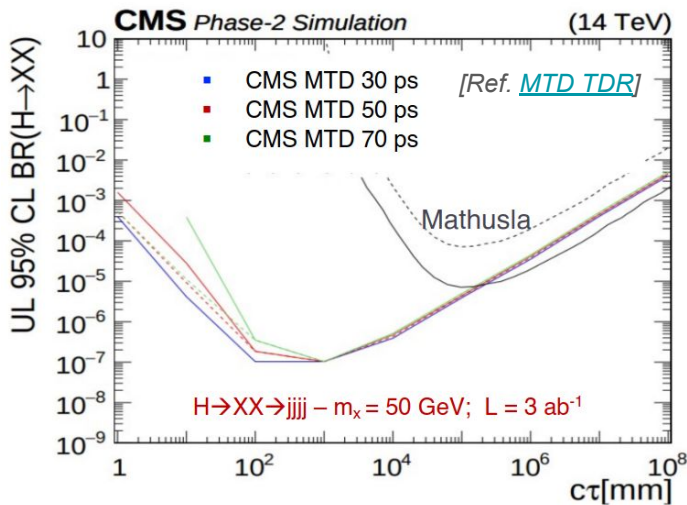
Vertex timing at e^+e^- colliders

- For beam optics “chromatization” schemes, the **particle energy correlates with the longitudinal particle position in the bunch**, and thus to the collision time
- Vertex timing with **$O(5 \text{ ps})$** precision offers a **\sqrt{s} scan at fixed centre-of-mass energy** (e.g. scan of the Higgs resonance for a run at the Higgs pole)
[[Azzi and Perez, FCC-ee, 2020](#)]
- Vertex time resolution ($\sigma_{\text{VTX}} \sim \sigma_{\text{TRK}} / \sqrt{N_{\text{tracks}}}$) and clock synchronization $\ll 5 \text{ ps}$

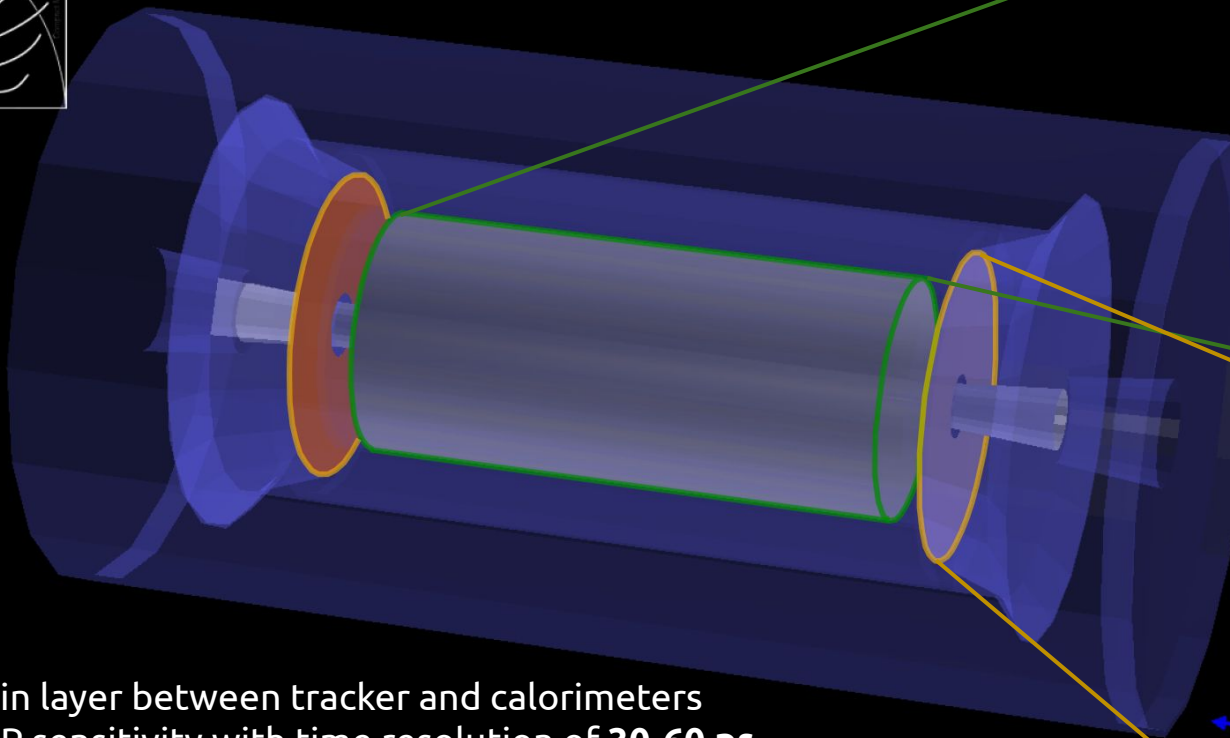


Time-of-flight detector

- Potential for **direct measurement of Long Lived Particles** (LLPs) mass by reconstruction of the time of the displaced vertices
 - The large multiplicity of final state topologies softens the requirements on time resolution
 - Will this remain of interest after HL-LHC?
- **Hadron identification for flavour physics and jet flavour tagging**
 - A compelling physics case for e⁺e⁻ colliders [[Bedeschi et al, 2202.03285](#)]
 - A TOF detector providing an “unchallenging” resolution of **O(100 ps) at 2 m** could cover the “ π/K cross-over window” at ~ 1 GeV, where dE/dx is blind



The Mip Timing Detector: an example from CMS upgrade



- Thin layer between tracker and calorimeters
- MIP sensitivity with time resolution of **30-60 ps**
- Hermetic coverage for $|\eta| < 3.0$

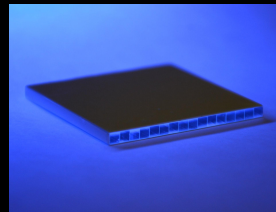
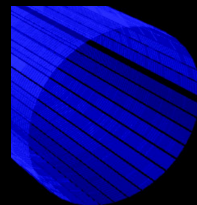
BARREL

Surface $\sim 38 \text{ m}^2$

Number of channels $\sim 332\text{k}$

Radiation level $\sim 2 \times 10^{14} \text{ n}_{\text{eq}}/\text{cm}^2$

Sensors: LYSO crystals + SiPMs



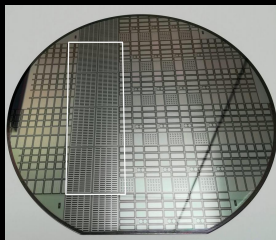
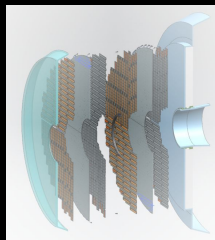
ENDCAPS

Surface $\sim 14 \text{ m}^2$

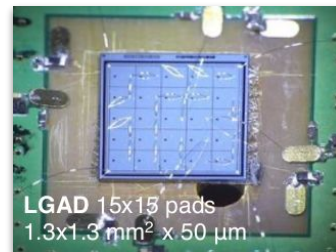
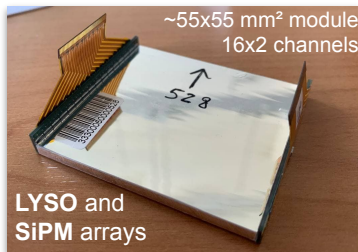
Number of channels $\sim 8500\text{k}$

Radiation level $\sim 2 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$

Sensors: Low gain avalanche detectors



Rough comparison of MTD technologies

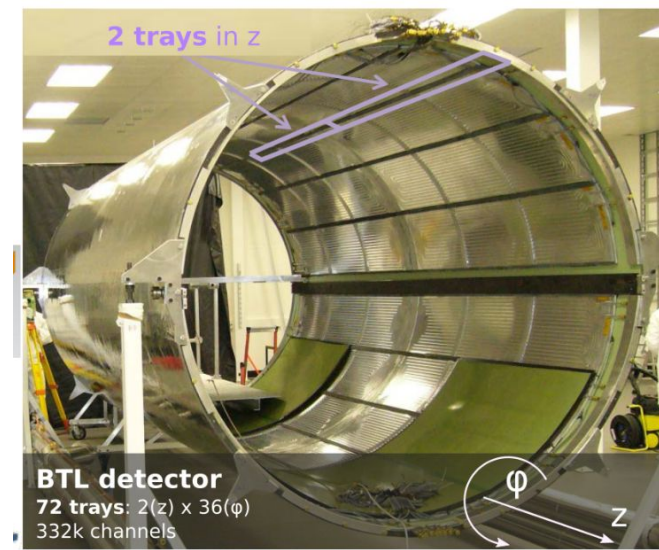


<i>[from MTD TDR]</i>	Barrel region	Endcap region
Total surface	38 m ²	16 m ²
Sensor technology	LYSO+SiPMs	LGADs
Highest radiation level [1 MeV n.eq./cm ²]	2e14	2e15
Cost / m ²	~250 k€	~700 k€
Power consumption / m ²	~1 kW (50% from radiation damage)	~5 kW
Channel count / m ²	~9k	~530k
Radiation length [X0]	0.3-0.5 (dominated by sensors)	0.15 (dominated by mechanics/services)
Time resolution (before/after irradiation)	30 / 60+ (limited by radiation damage)	40 / 40 (contribution from electronic noise)

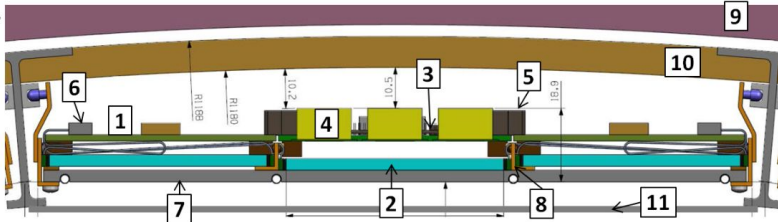
- Different technologies are best suited for different environments/constraints
- In the absence of heavy radiation damage LYSO+SiPM offer a viable option for the instrumentation of **large surfaces with contained cost, channel count and power budget**

Detector integration challenges - BTL

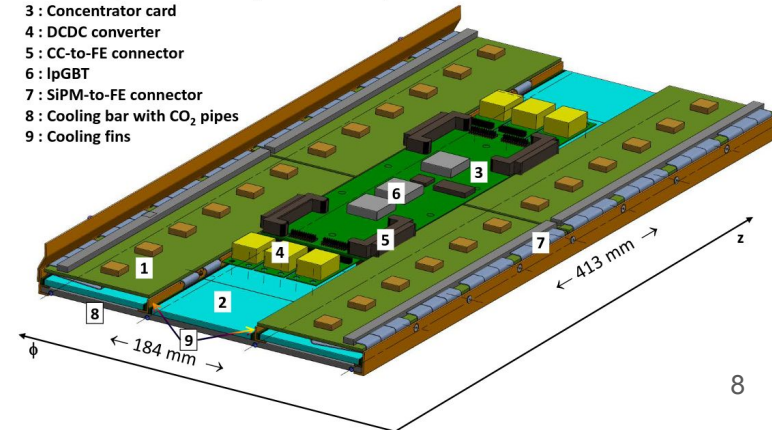
- **Space**: sensors, electronics and services had to fit within a **4 cm radial envelope** (detector will be inserted inside the new tracker support tube!)
- CO₂ based system to extract **heat** from SiPMs and electronics and cool down to -35°C (*only required to mitigate radiation damage effects*)
- **Radiation length** in front of ECAL($\sim 0.4 X_0$) has no impact on calorimeter performance



- 1 : TOFHIR board with 6 ASICs
- 2 : LYSO array with 16 LYSO bars, bars oriented in ϕ
- 3 : Concentrator card
- 4 : DCDC converter
- 5 : CC-to-FE connector
- 6 : SiPM-to-FE connector
- 7 : Cooling bar with CO₂ pipes
- 8 : Cooling fins
- 9 : TST
- 10 : Insulation
- 11 : BTL compartment cover plate



- 1 : TOFHIR board with 6 ASICs
- 2 : LYSO array with 16 LYSO bars, bars oriented in ϕ
- 3 : Concentrator card
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- 6 : IpGBT
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BTL sensors highlights

- **3x3x50 mm³ LYSO:Ce scintillating crystals** packaged and wrapped in arrays already from manufacturer (10+ vendors worldwide)
- **Custom developed Silicon Photomultiplier arrays** optimized for timing and radiation tolerance (2 vendors tested)
- **Mini thermoelectric coolers** integrated with SiPM package for “smart” temperature control

A. Bornheim et al 2023 JINST 18 P08020

<https://doi.org/10.1088/1748-0221/18/08/P08020>

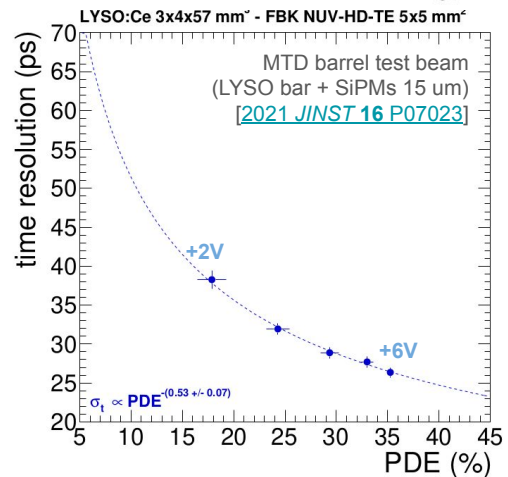
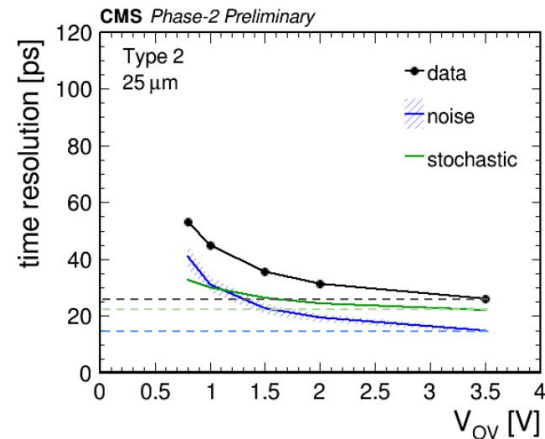


Resolution drivers in scintillator+SiPM timing detectors

- *Without* radiation damage time resolution in BTL is limited by
 - Electronic noise ~15 ps
 - Photo-statistics (sensors) ~ 22 ps
- There are **handles to customize the detector design**

$$\sigma_t^{\text{phot}} \propto \sqrt{\frac{\tau_r \tau_d}{N_{\text{phe}}}} \propto \sqrt{\frac{\tau_r \tau_d}{E_{\text{dep}} \cdot \text{LY} \cdot \text{LCE} \cdot \text{PDE}}}$$

Scintillation rise and decay time constants
 Energy deposited in the scintillator (~thickness, density)
 Scintillation Light Yield
 Light Collection Efficiency
 SiPM Photon Detection Efficiency (~cell size, operating voltage)

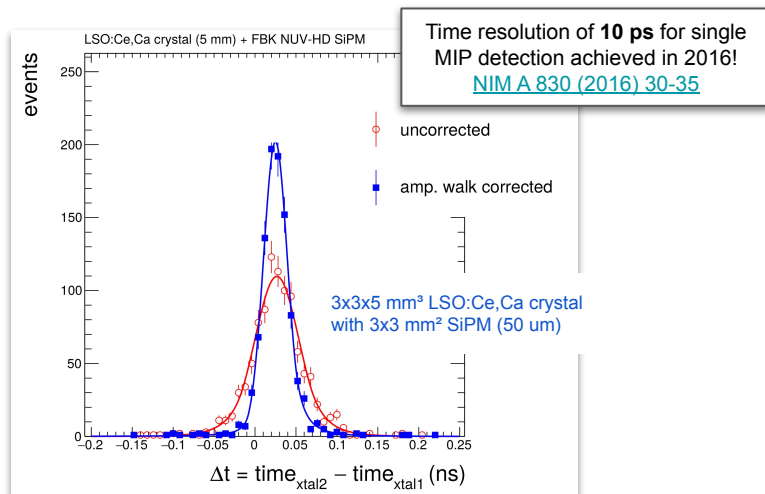


Flexibility and optimization in scintillator+SiPM timing detectors

Keep the material fixed and *work on design/photodetector*

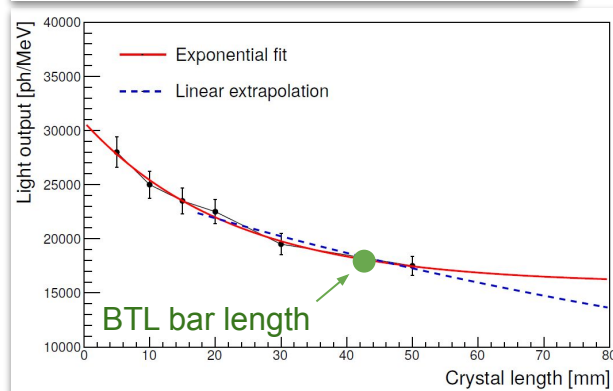
++ Performance

- Operation at larger over-voltage
- Use of SiPMs with larger cell size
- Increase granularity
- Increase crystal thickness



++ Integration

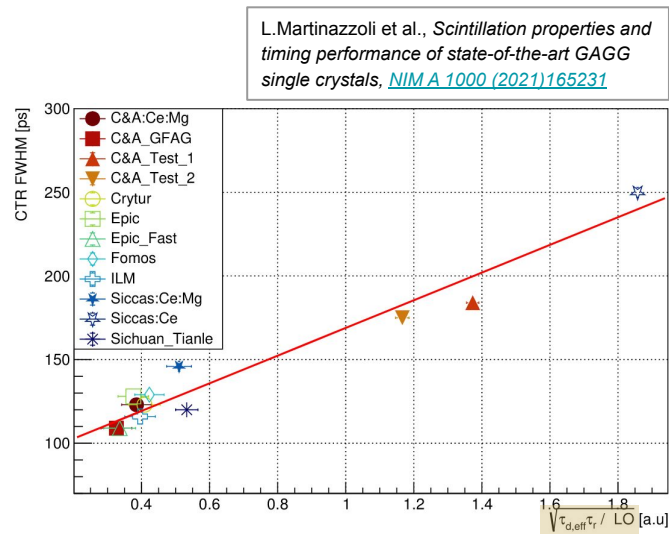
- Increasing crystal length exploiting total internal reflection
- Reduce SiPM channel count, cost and power consumption



Flexibility and optimization in scintillator+SiPM timing detectors

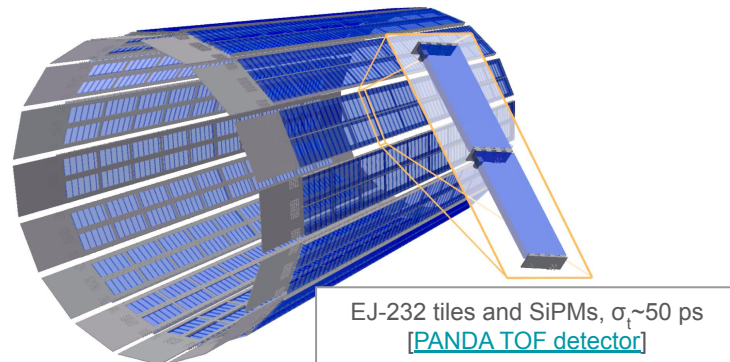
Keep the detector design fixed and *optimize the scintillator*










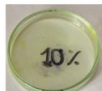


- Key features of LYSO for a timing detector
 - Good radiation tolerance
 - Competitive cost and mass production capability
 - Emission wavelength matching common SiPM technologies
 - Easy to handle (not hygroscopic, not too brittle)
 - Good scintillation properties for timing $\sim \sqrt{(T_R T_D / LY)}$
- Competing with LYSO: faster, brighter, denser
 - Exploit **bandgap engineering** to push against scintillator limits, e.g. with multicomponent garnet crystals
 - Exploiting **ultra fast-emission processes** (**Cherenkov**, hot intraband luminescence, **cross-luminescence**)
→ typically more in the UV → challenging photodetection



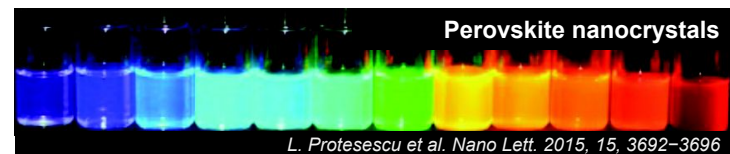
Crystals vs other scintillators

- **Plastic scintillators** with sub-ns decay time broadly explored and exploited for timing (and also for sampling calorimeters)
 - **Less radiation tolerant than crystals but perfectly fine for an e⁺e⁻ collider!**
 - Lower energy deposited by MIPs
 - **Could reduce timing layer cost by ~20% compared to crystals**
- **Nano scintillators** with sub-ns scintillation may also represent a further leap towards precision timing
 - A recent stimulating frontier with open challenges for detector applications (medium opacity, low density, ...)



CsPbBr ₃ OA + OAm		CsPbBr ₃ DDAB	
Photograph	Petri dish	Photograph	Petri dish
			
			
			

[K. Děcká et al.](#),
Timing performance of lead halide perovskite nanoscintillators embedded in a polystyrene matrix,
J. Mater. Chem. C, 2022



Maximum information crystal calorimeter for IDEA

- Precision timing for charged particles and EM showers
- Higher segmentation for PID and particle flow algorithms
- SiPM readout for contained cost and power budget

- **Timing layers** • $\sigma_t \sim 20$ ps

- LYSO:Ce crystals ($\sim 1X_0$)
- $3 \times 3 \times 60$ mm³ active cell
- 3×3 mm² SiPMs (15-20 μ m)

- **ECAL layers** • $\sigma_E^{\text{EM}}/E \sim 3\%/\sqrt{E}$

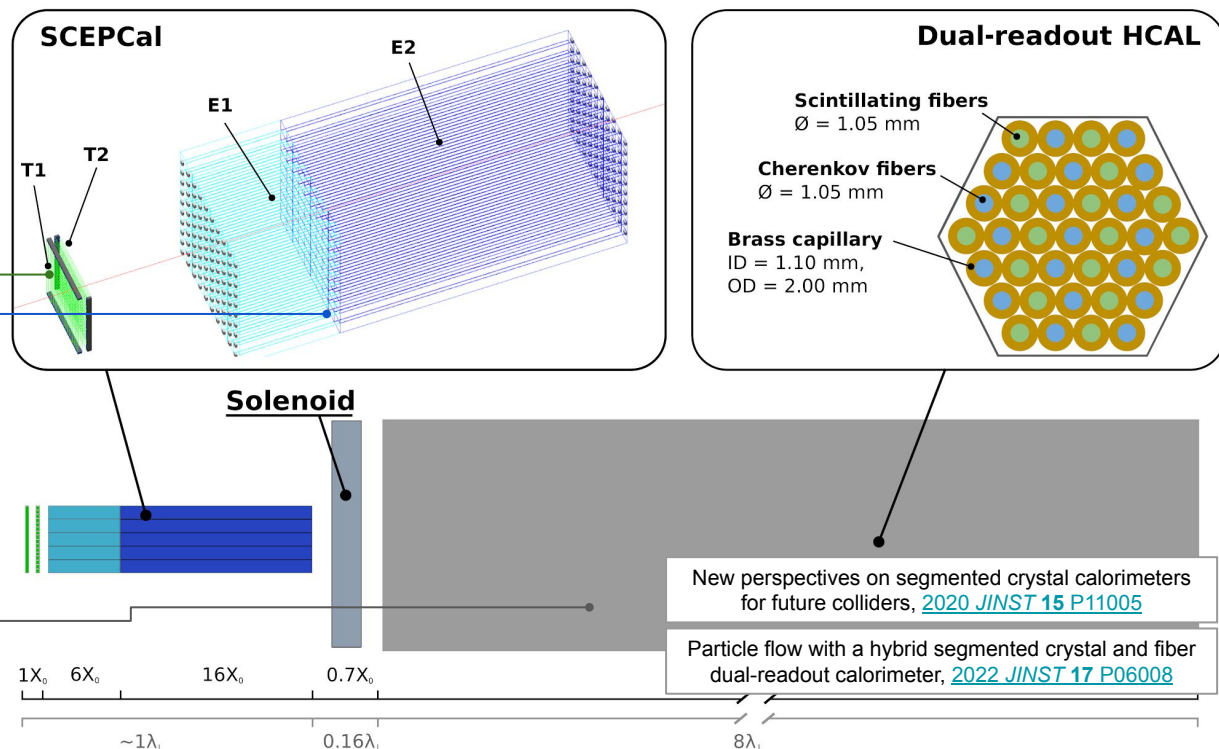
- PWO crystals
- Front segment ($\sim 6X_0$)
- Rear segment ($\sim 16X_0$)
- $10 \times 10 \times 200$ mm³ crystal
- 5×5 mm² SiPMs (10-15 μ m)

- **Ultra-thin IDEA solenoid**

- $\sim 0.7X_0$

- **HCAL layer** • $\sigma_E^{\text{HAD}}/E \sim 26\%/\sqrt{E}$

- Scintillating and “clear” PMMA fibers (for Cherenkov signal) inserted inside brass capillaries



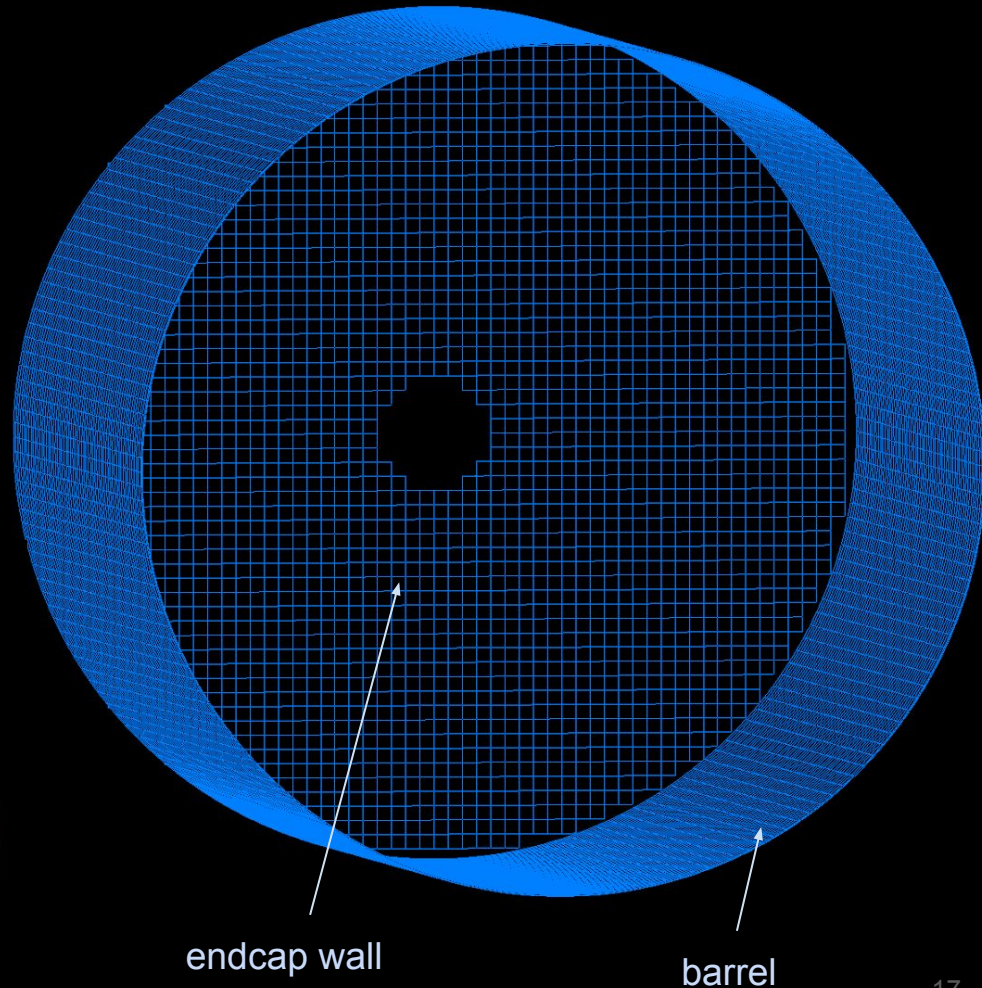
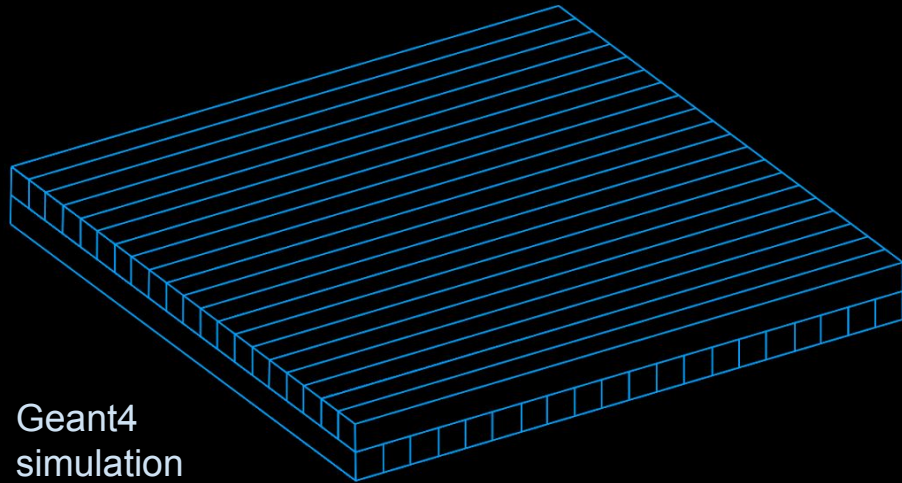
Summary

- MIP **timing technologies** for vertex tracking and TOF developed for HL-LHC experiments can **already provide a time resolution that satisfies requirements** at e+e- colliders ($\sigma_t \sim 20\text{-}100$ ps)
- **Optimization** of a scintillator+SiPM based timing detector **for an e+e- collider** (low radiation environment) **can offer further improvement** of time resolution (<20 ps) at lower cost (<20%) compared to applications at HL-LHC
- A scintillator + SiPM timing layer can offer a more **natural integration with a homogeneous optical calorimeter** (it can provide a precise energy measurement and exploits similar technologies)
- **Integration challenges, cost and power consumption** are a big challenge and will most likely drive the sensor technology choice (LYSO+SiPMs chosen by MTD as more cost effective and less power hungry than LGADs in the “low” radiation region)

Additional material

Timing layers

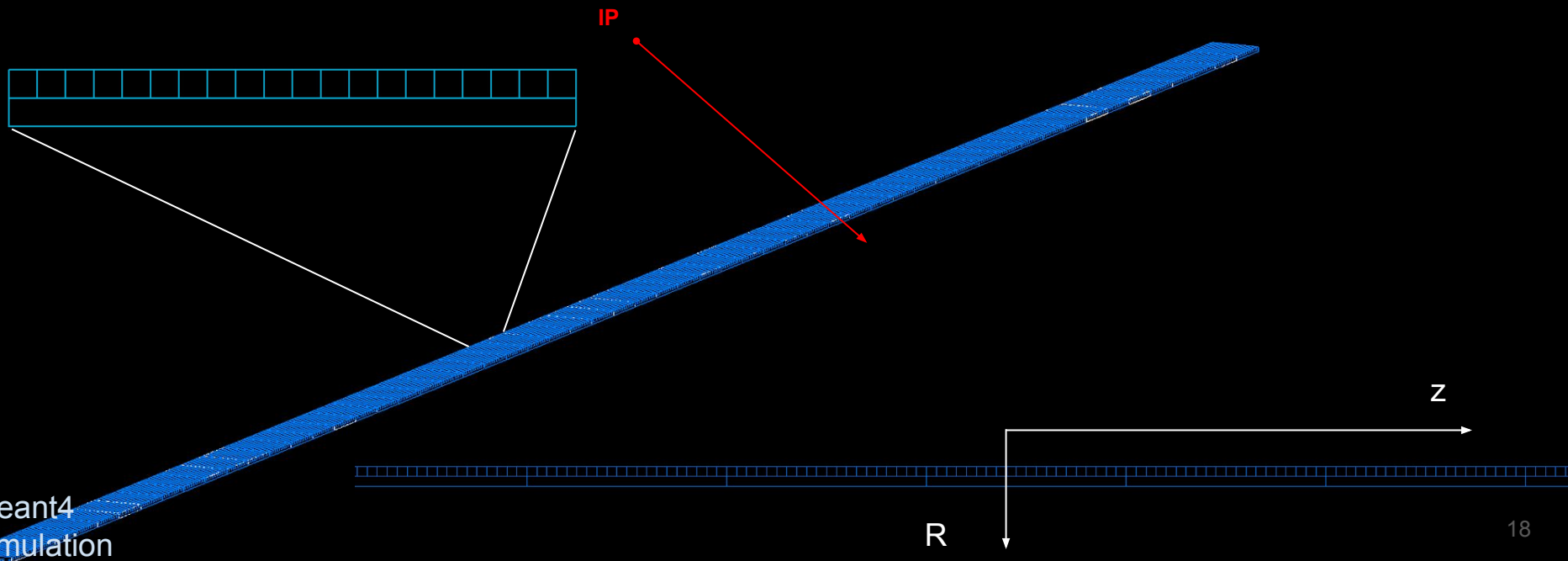
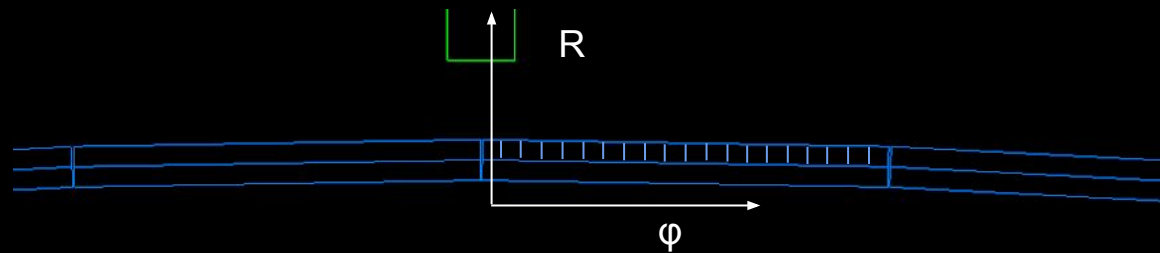
- Inner radius: 1775 mm
- Outer radius: 1795 mm
- Module size: $60 \times 60 \times 6 \text{ mm}^3$
- Crystal size: $60 \times 3 \times 3 \text{ mm}^2$



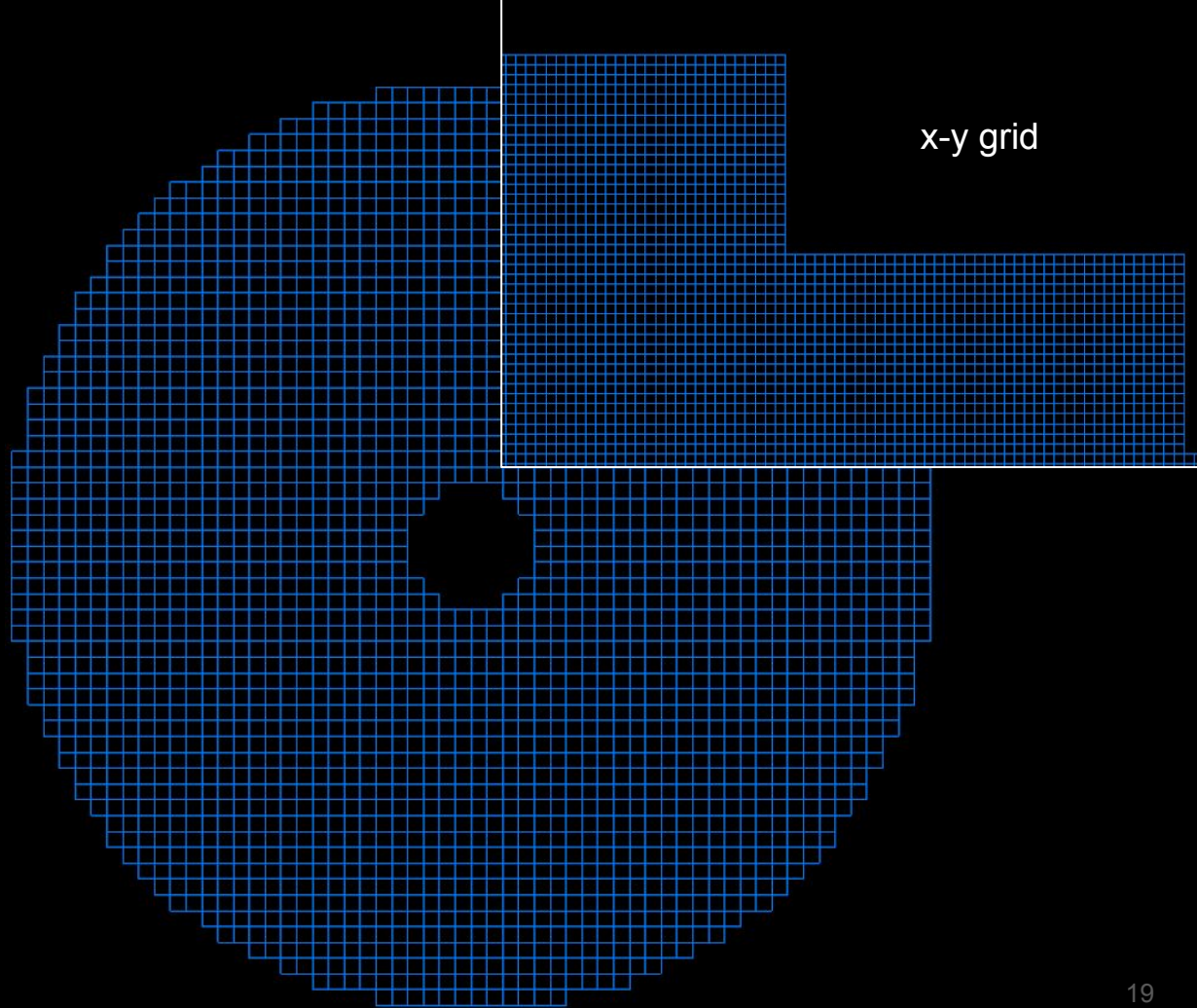
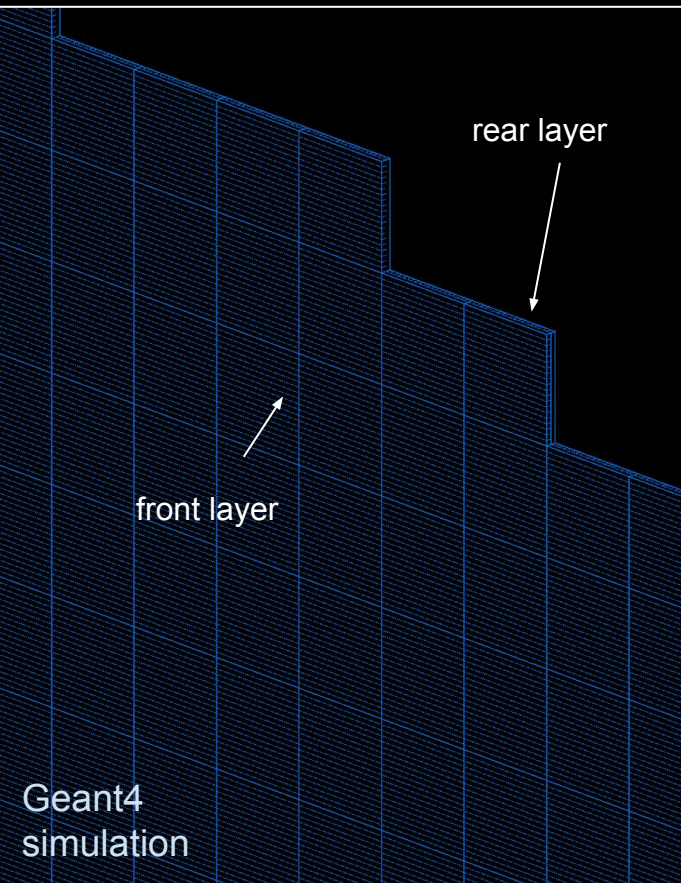
Geant4
simulation

Timing layer barrel

- Trays of modules running along z



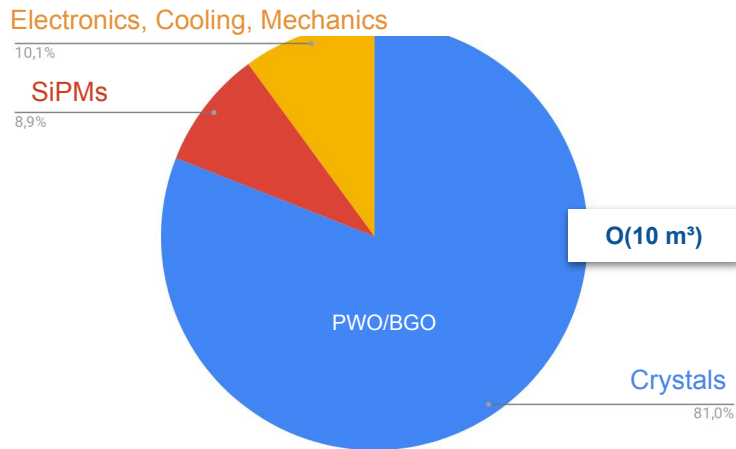
Timing layer endcap



The **cost** issue

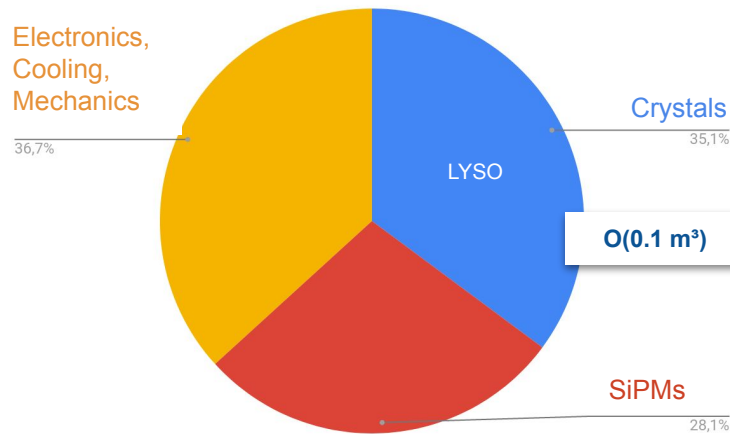
Costing exercise for an **hermetic EM homogeneous calorimeter**

($R=1.8$ m, 1 cm^2 transverse granularity,
2 longitudinal layers, $22X_0$, $\sim 600\text{k}$ channels / layer)



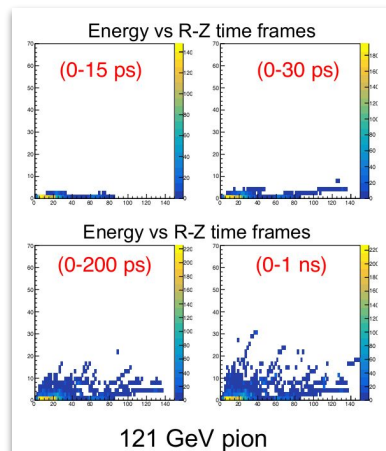
Costing exercise for an **hermetic timing layer**

(design à la MTD BTL)

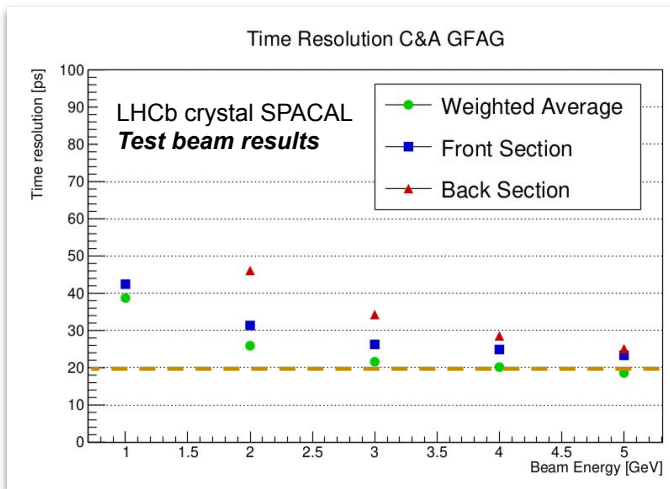


Timing *inside* calorimeters

- **Benefits:** timing for neutral particles and information on the time development of EM and HAD showers
- Typically implies dealing with ‘large’ energy deposits (many MIPs per active element)
- **State-of-the-art** examples (EM showers)
 - Time resolution of **~30 ps** for $E > 30$ GeV with the **CMS ECAL in Phase 2 Upgrade**
 - PWO+APDs
 - **Sub-20 ps** time resolution for $E > 5$ GeV with the crystal **SPACAL** for the LHCb upgrade
 - GFAG+PMTs

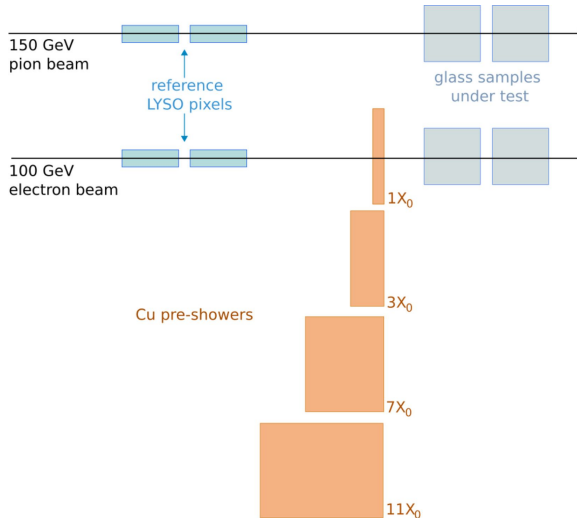
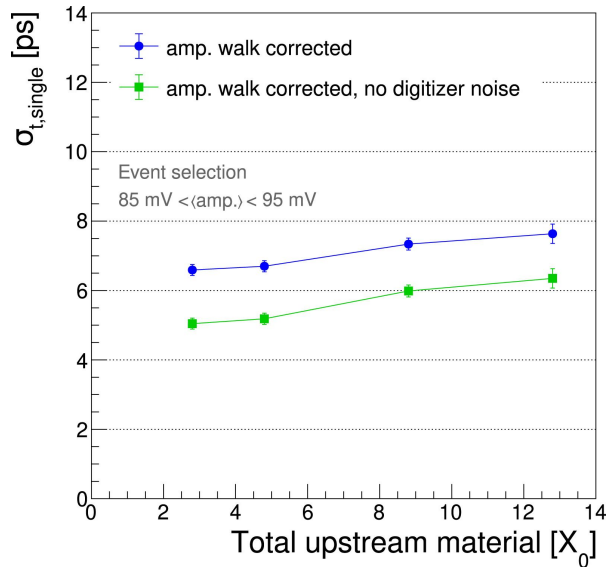


Timing to improve HAD shower reconstruction (simulation)
[See N.Ackurin @ECFA Symposium 2021](#)



Resolution to electromagnetic showers

- Time resolution of $O(5 \text{ ps})$ for EM showers within reach (glasses+SiPMs) at single sensor level \rightarrow most likely a challenge to scale it up (clock, electronics, etc.)



Sub-10 ps time tagging of electromagnetic showers with scintillating glasses and SiPMs

Nuclear Inst. and Methods in
Physics Research, A 1051
(2023) 168214

Time resolution drivers in BTL [updated]

$$\sigma_t^{\text{BTL}} = \sigma_t^{\text{clock}} \oplus \sigma_t^{\text{digi}} \oplus \underbrace{\left(\sigma_t^{\text{ele}} \oplus \sigma_t^{\text{phot}} \oplus \sigma_t^{\text{DCR}} \right)}_{\text{dominant contributions}}$$

Time resolution driven by photon signal (**S**),
radiation induced dark counts (**N**) and
electronic signal rising slope (**dI/dt**):

$$\left\{ \begin{array}{l} S = \overset{\text{crystals}}{E_{\text{dep}} LY} \cdot \overset{\text{crystals + SiPM}}{LCE} \cdot \overset{\text{SiPM}}{PDE} \\ N = \overset{\text{SiPM}}{\sqrt{\text{DCR}}} \\ dI/dt \propto S \cdot \overset{\text{SiPM}}{\text{Gain} \cdot f(R_q, C_g)} \cdot \overset{\text{TOFHIR}}{\xi(\text{ASIC})} \end{array} \right.$$

E_{dep} : energy deposit by MIP
 LY : crystal light yield
 LCE : light collection efficiency
 PDE : photon detection efficiency
 DCR : rate of dark counts
 R_q : quenching resistor
 C_g : grid capacitance

$$\left\{ \begin{array}{l} \sigma_t^{\text{phot}} \propto \frac{1}{\sqrt{S}} \\ \sigma_t^{\text{DCR}} \propto \frac{N}{S} \\ \sigma_t^{\text{ele}} \propto \frac{\sigma_{\text{noise,ele}}}{dI/dt} \end{array} \right.$$

